

ICNME 2019

CHENG DU, CHINA

APRIL 25-27, 2019

IOP Conference Series

INTRODUCTION

The 7th International Conference on Nanomaterials and Materials Engineering in Chengdu, China during April 25-27, 2019. It is mainly organised by International Academy of Computing Technology (IACT) and technically supported by some universities and associations. This unique international conference provides a forum for academics, researchers and practitioners from many industries to exchange ideas and share recent developments in the field of Nanomaterials and Materials Engineering

Important Date

Submission

15th December 2018

Notifications

05th January 2019

Camera-Ready

20th January 2019

Registration

20th January 2019

Contact Us

- Conference coordinator:
Ms. Yoko Su
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And the telephone will be available from 10:00-17:30 on weekdays, except the holidays

Submission Guideline

- Full Paper/Publication
- Abstract/Oral Presentation Only (Not publication)
- Template:
<http://www.icnme.org/Format.doc>
x
- EasyChair Submission
System: <http://www.easychair.org/conferences/?conf=icnme2019>

Publication

- All accepted and presented papers will be published in IOP Conference Series: Materials Science and Engineering, which will submitted for Conference Proceedings Citation Index - Science (CPCI-S)(Thomson Reuters, Web of Science), Scopus, EI Compendex, EI Inspec, INIS (International Nuclear Information System), Chemical Abstracts, NASA Astrophysics Data System, Polymer Library, etc.

Conference Topics

Nanomaterials and Nanotechnology
Biomaterials and Biomedical Engineering
Ceramic and Glass Materials
Crystal Defect Engineering
Crystallographic Domain Engineering
Domain Microstructure Evolution
Electronic and Magnetic Materials
Experimental Characterizations
Nanotechnology and Materials
Shape Memory Alloys and Martensites

More information:

<http://www.icnme.org/cfp.html>

Note:

- Special discount will be given to those who finish the registration before January 20, 2019.